



#### **GLASS PASSIVATED RECTIFIER**

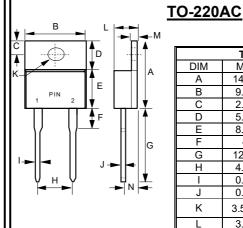
### REVERSE VOLTAGE - 1000 Volts FORWARD CURRENT - 16 Ampere

#### **FEATURES**

- · Glass passivated chip
- Low forward voltage drop and high current capability
- Low reverse leakage current
- High surge capacity

#### **MECHANICAL DATA**

- Case: TO-220AC molded plastic
- Plastic package has UL flammability classification 94V-0
- Polarity: As marked on the bodyWeight: 0.079 ounces, 2.24 grams
- Mounting position: Any



#### TO-220AC DIM MIN MAX 14.22 15.88 Α В 10.67 9.65 2.54 3.43 D 5.84 6.86 8.26 9.28 6.35 G 12.70 14.73 Н 4.83 5.33 1.14 0.51 J 0.30 0.64 Κ 3.53Ф 4.09Ф 3.56 4.83 М 1.14 1.40 Ν 2.03 2.92

All Dimensions in millimeter

REV-0, Jul-2019, KSDA09

#### MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified.

#### **ABSOLUTE RATING**

Parameter		Symbol	Value	Units
Maximum Repetitive Peak Reverse Voltage		$V_{RRM}$	1000	V
Maximum DC Blocking Voltage		VDC	1000	V
Maximum Average Forward Rectified Current Tc=90℃	(with heatsink Note 4) (without heatsink Note 3)	IAV	16 3.3	Α
Peak Forward Surge Current @ tp=8.3ms, Tj=25℃		IFSM	225	Α
Peak Forward Surge Current @ tp=1.0ms, Tj=25℃		IFSM	450	А
Operating Temperature Range		TJ	-55 ~ +150	°C
Storage Temperature Range		T <sub>STG</sub>	-55 ~ +150	$^{\circ}\!\mathbb{C}$

PIN 1

PIN 2 o-

#### STATIC ELECTRICAL CHARACTERISTICS

Parameter	Test condition		Symbol	Value	Unit
Forward Voltage Note(1)	IF=16A	Tj=25°C	VF	1.1	V
Reverse Leakage current	At VR rated	Tj=25℃ Tj=125℃	IR	10 250	uA
Typical Junction Capacitance (Note2)		Cj	100	pF	

#### THERMAL PERFORMANCE

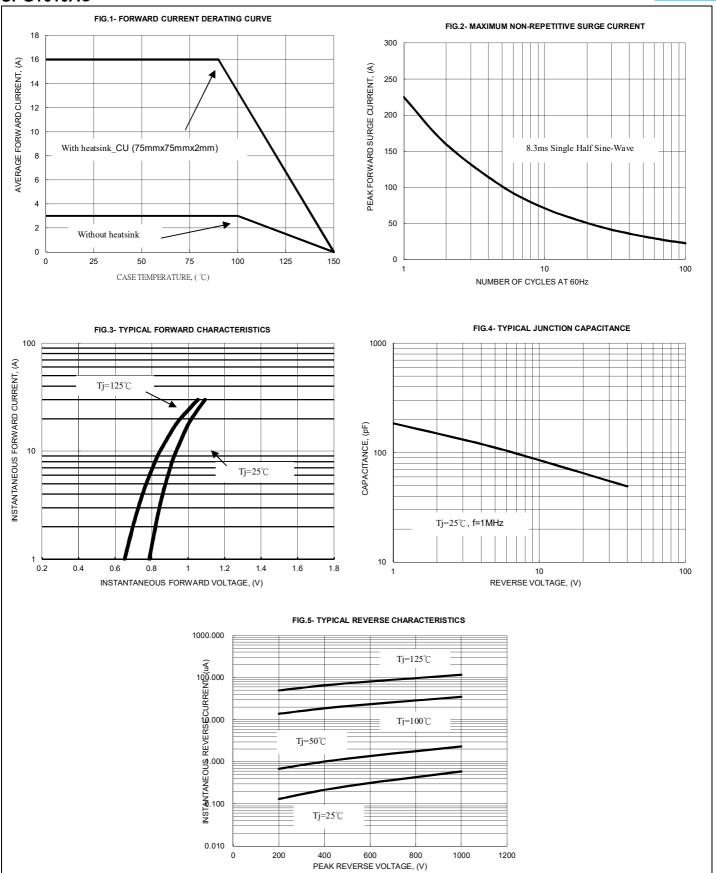
Parameter		Тур.	Unit
Typical Thermal Resistance (Note 3,) (without heatsink)	RthJ <sub>C</sub> RthJ <sub>a</sub>	10 35	°C/W
Typical Thermal Resistance (Note 3,4) (with heatsink)	RthJ <sub>C</sub> RthJ <sub>a</sub>	2 5	°C/W

#### Note:

- (1) 300us Pulse Width, 2% Duty Cycle.
- (2) Measured at 1.0MHz and applied reverse voltage of 4.0V DC
- 3) Thermal Resistance test performed in accordance with JESD-51.
- 4) Device mounted on 75mm x 75mm x 2mm Cu Plate Heatsink.

# RATING AND CHARACTERISTIC CURVES SPG1610AC







## **Important Notice and Disclaimer**

LSC reserves the right to make changes to this document and its products and specifications at any time without notice. Customers should obtain and confirm the latest product information and specifications before final design, purchase or use.

LSC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does LSC assume any liability for application assistance or customer product design. LSC does not warrant or accept any liability with products which are purchased or used for any unintended or unauthorized application.

No license is granted by implication or otherwise under any intellectual property rights of LSC.

LSC products are not authorized for use as critical components in life support devices or systems without express written approval of LSC.